



BYD Microelectronics Co., Ltd.

BF9038DNS-A

Dual N-Channel MOSFET

General Description

The BF9038DNS-A is a dual N-channel MOS Field Effect Transistor, which is applied to electronic systems as a power switch. This device has ESD-protection and low resistance characteristics.

Features

- V_{DS} (V) = 30V
- Can be driven by a 2.5 V power source
- Low on-state resistance
 $R_{DS(on)} = 17 \text{ m}\Omega$ TYP ($V_{GS} = 4.5\text{V}$, $I_D = 2.0\text{A}$)
 $R_{DS(on)} = 22 \text{ m}\Omega$ TYP ($V_{GS} = 2.5\text{V}$, $I_D = 2.0\text{A}$)
- Composite type, facilitating high-density mounting.

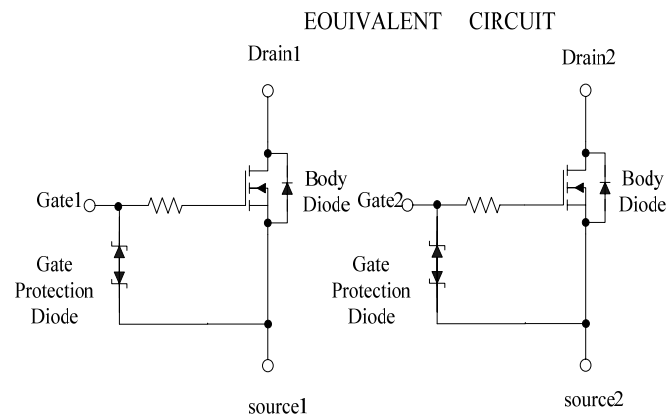
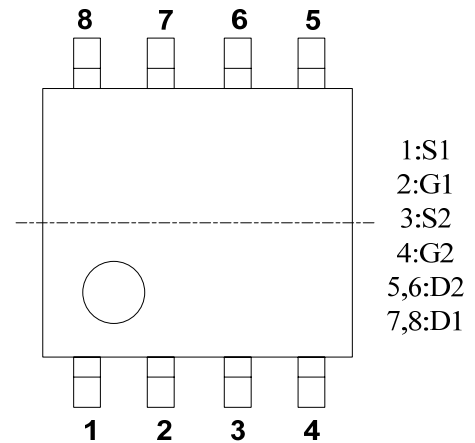
Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

PARAMETER	SYMBOL	RATINGS	UNIT
Drain to Source Voltage	V_{DSS}	30	V
Gate to Source Voltage	V_{GSS}	± 10	V
Drain Current (DC)	$I_{D(DC)}$	8	A
Drain Current (pulse) ^a	$I_{D(pulse)}$	52	A
Total Power Dissipation ^b	P_T	3.0	W
Channel Temperature	T_{ch}	150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55~+150	$^\circ\text{C}$

Caution: These values must not be exceeded under any conditions.

Ordering Information

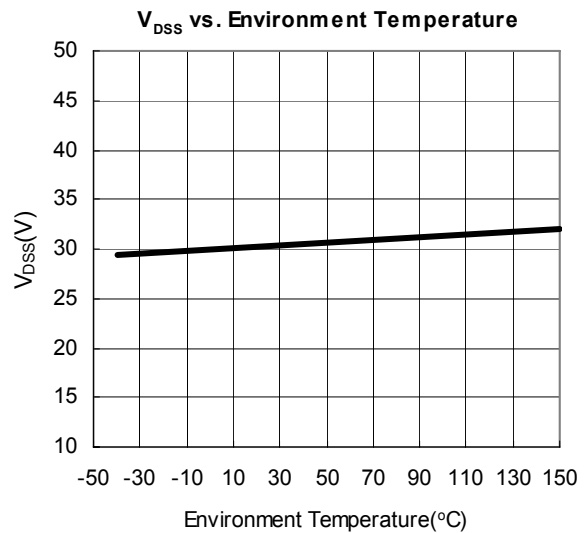
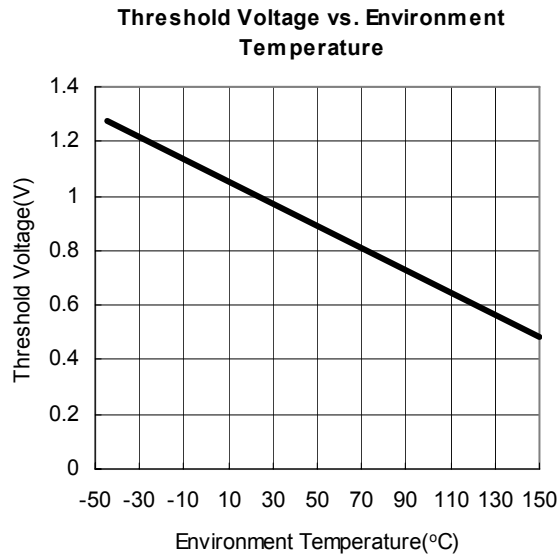
- Part Number: BF9038DNS-A
- Package: SOIC8

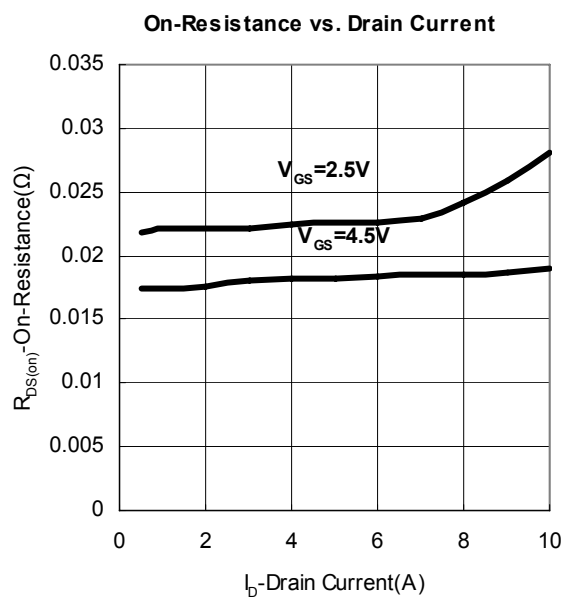
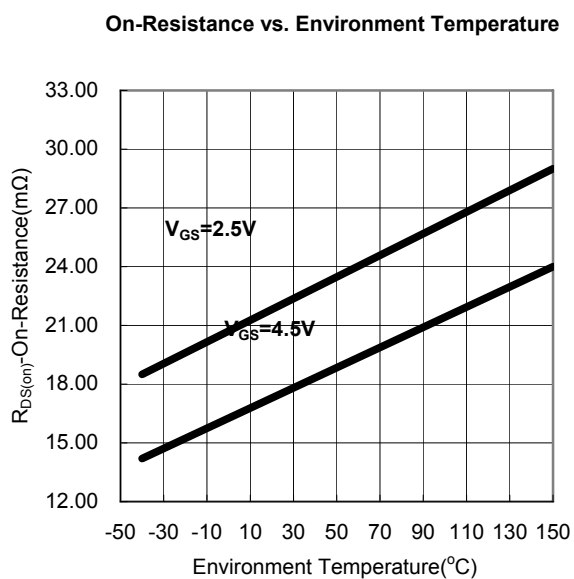
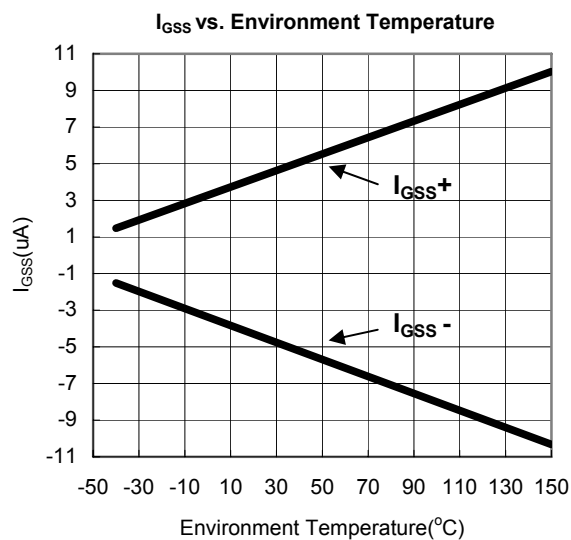
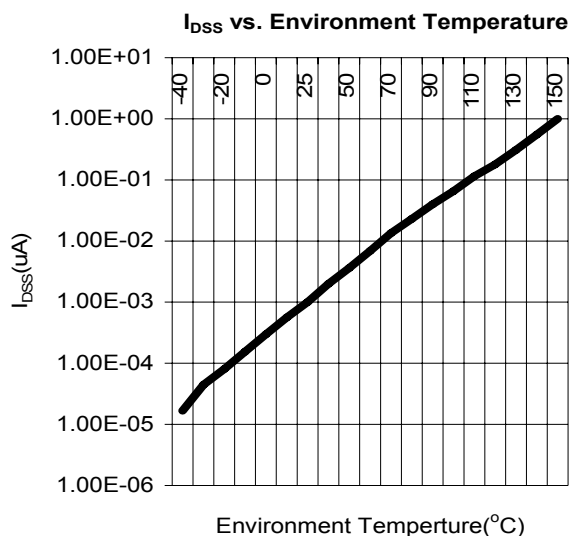


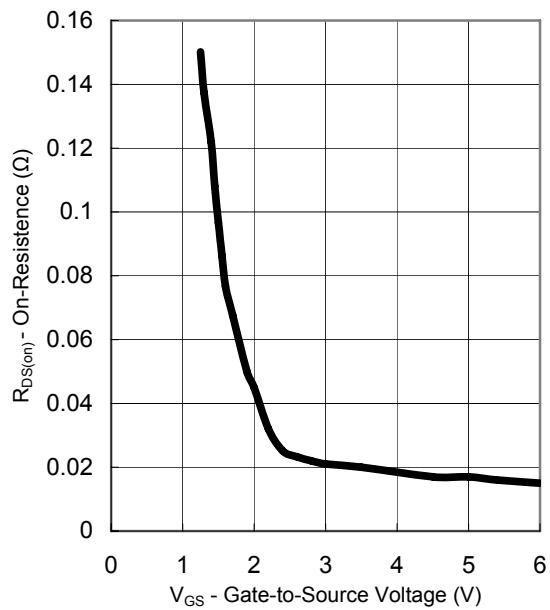
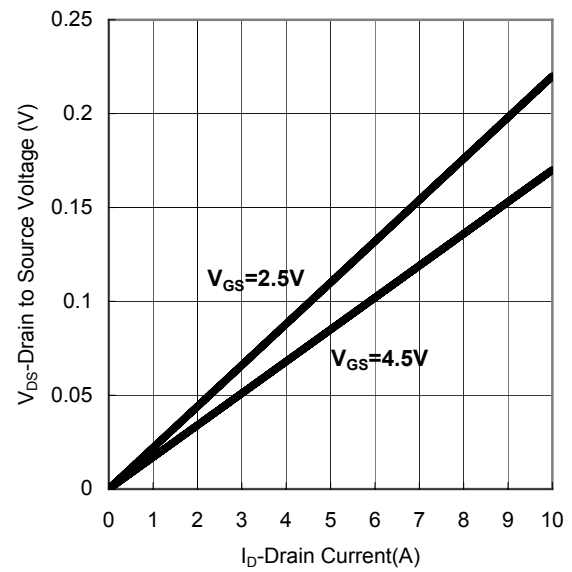
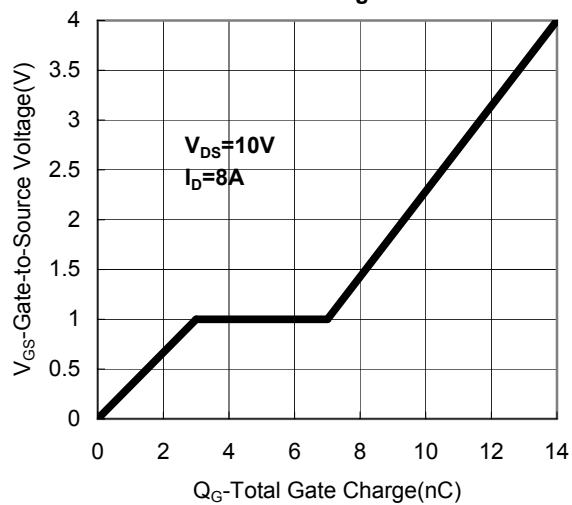
Electrical Characteristics ($T_A = 25^\circ\text{C}$)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=30V, V_{GS}=0V$			10	μA
Gate Leakage Current	I_{GSS}	$V_{GS}=\pm 10V, V_{DS}=0V$			± 10	μA
Gate Cut-off Voltage	$V_{GSS(off)}$	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	0.5		1.5	V
Forward Transfer Admittance	$ y_{fs} $	$V_{DS}=10V, I_D=8A$		13		S
Drain to Source On-state Resistance	$R_{DS(on)1}$	$V_{GS}=4.5V, I_D=2A$		17	23	$\text{m}\Omega$
	$R_{DS(on)4}$	$V_{GS}=2.5V, I_D=2A$		22	32	$\text{m}\Omega$
Input Capacitance	C_{iss}	$V_{DS}=10V,$		1400		pF
Output Capacitance	C_{oss}	$V_{GS}=0V$		180		pF
Reverse Transfer Capacitance	C_{rss}	$f=1\text{MHz}$		35		pF
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=10V,$ $I_D=3A,$ $V_{GS}=4V,$ $R_G=10\Omega$		90		ns
Rise Time	t_r			190		ns
Turn-off Delay Time	$t_{d(off)}$			695		ns
Fall Time	t_f			420		ns
Total Gate Charge	Q_G	$V_{DS}=10V,$		14		nC
Gate to Source Charge	Q_{GS}	$V_{GS}=4V,$		3		nC
Gate to Drain Charge	Q_{GD}	$I_D=8A$		4.5		nC
Body Diode Forward Voltage	$V_{F(S-D)}$	$I_F=8A, V_{GS}=0V$		0.85	1.2	V

Typical characteristics (25°C unless noted)



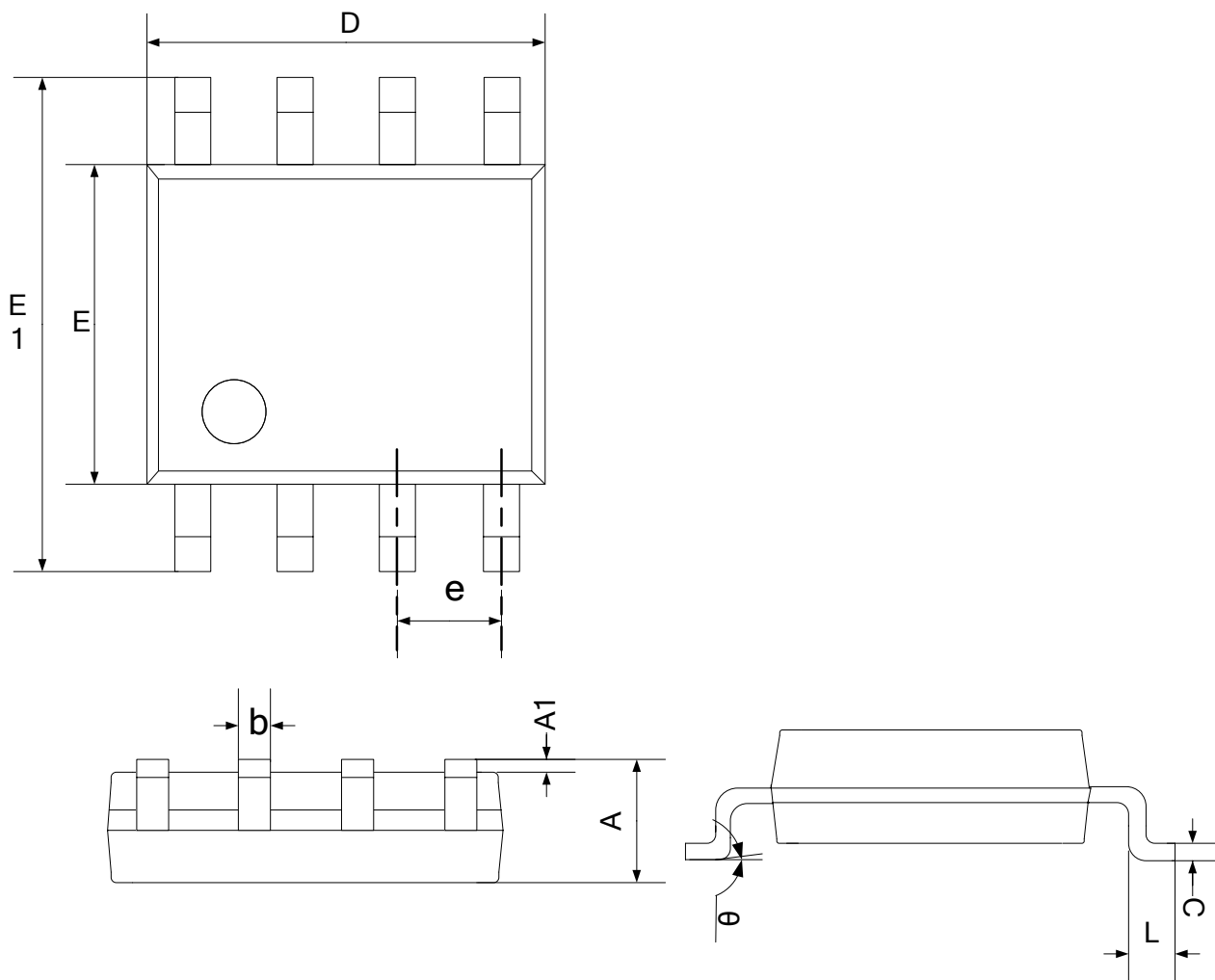


On-Resistance vs. Gate-to-Source Voltage

Drain to Source Voltage vs. Drain Current

Gate Charge


Package Drawing

SOIC8

UNIT (mm)



Dimensions

	D	E	A	E1	A1	C	L	b	e	θ
Min.	4.80	3.80	1.35	5.80	0.100	0.19	0.500	0.380	1.27 BSC	0°
Nom.	4.90	3.90	1.55	6.00	0.175	0.22	0.715	0.445		4°
Max.	5.00	4.00	1.75	6.20	0.250	0.25	0.930	0.510		8°